

Features

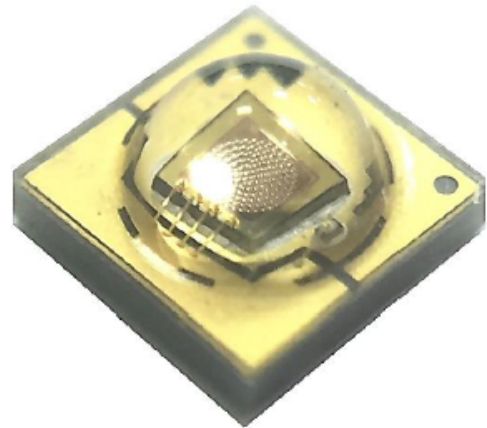
- 3535 IR VCSEL
- ROHS and REACH Compliant
- ESD(HBM) 4KV
- MSL 4 Qualified (J-STD 020)

Applications

- Industrial facility applications
- Consumer Mobile
- Automotive Interior & Exterior
- 3D Sensing(TOF, Structure Light)
- Bio recognition

Description

The INV-C33CTMIR is a high-power IR VCSEL. It is a SMD type package which can be used in various applications.



Recommended Solder Pattern

(Suggest Stencil t=0.12 mm)

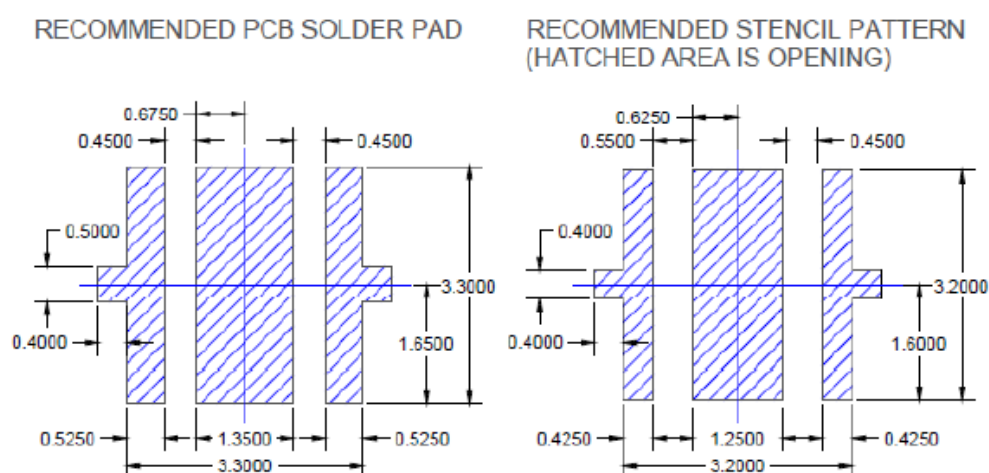


Figure 1. INV-C33CTMIR Recommended Solder Pattern

Note:

*All dimensions are in millimeters.

*Tolerance is ± 0.05 mm unless other specified.

Package Dimensions in mm

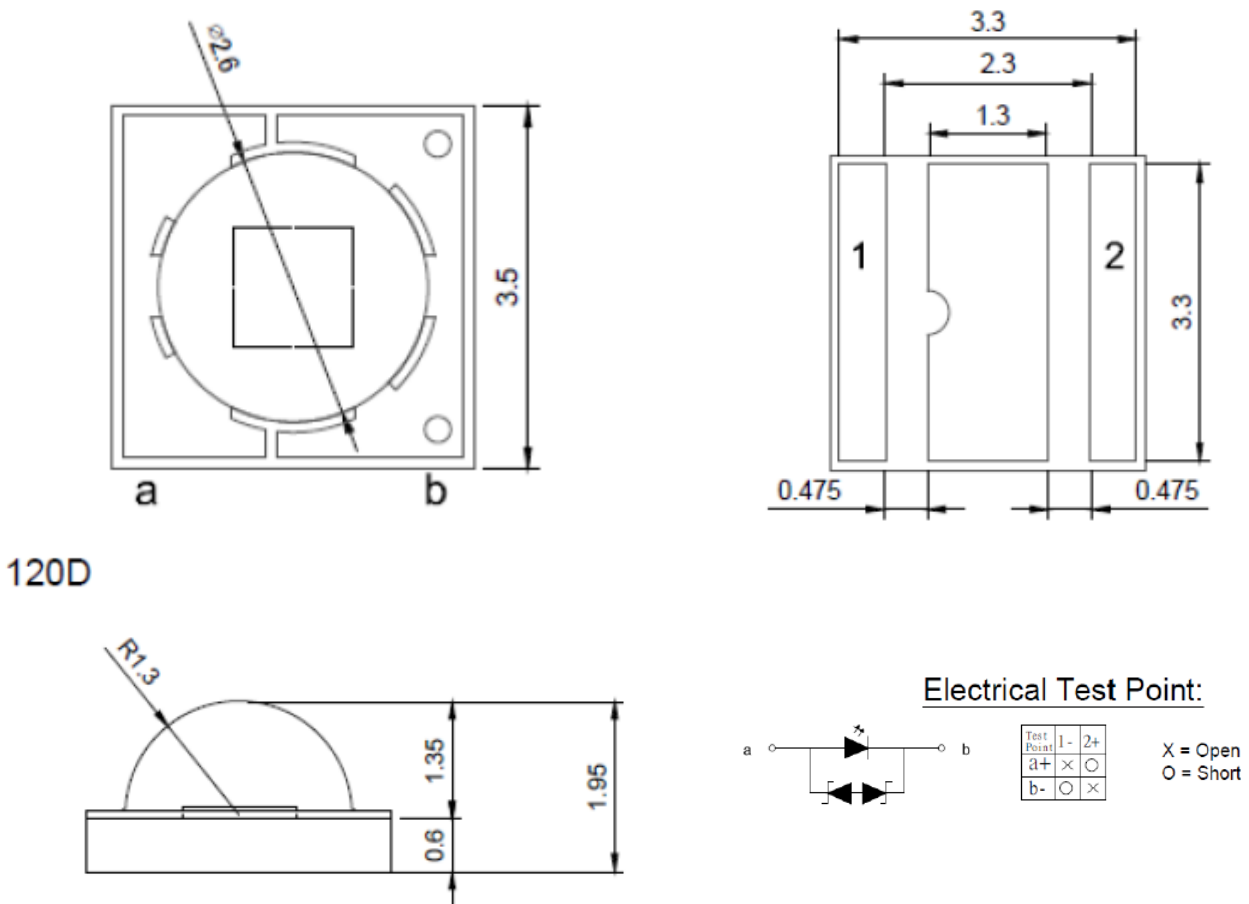


Figure 2. INV-C33CTMIR Package Dimensions

***Note**

All dimensions are in millimeters. Tolerance is $\pm 0.05\text{mm}$ unless other specified.

Absolute Maximum Rating at 25°C (Note 1)

Product	I _{FP} (mA) max Pulse Current (@1/10 duty)	DC Forward Current (mA)		V _R (V) Typ.	T _j (°C) Typ.	T _{ST} (°C)	R _{th} (°C/W)	Soldering Temp. T _{sol} (°C)
INV-C33CTMIR	900	typ.	max.	-5	110 °C	-40°C~+100°C	20	260 °C
		700	800					

Notes

1. For other ambient, limited setting of current will depend on de-rating curves.
2. D=0.01s duty 1/10.
3. When drive on maximum current , T_j must be kept below 110°C
4. Viewing angle(2 θ 1/2) ± 10°

Electrical Characteristics T_A = 25°C (Note 1)

Product	V _F (V)@700mA		Radiometric Power (mW) @700mA		Peak Wavelength (nm)		I _R (μA)	View Angle
	min	max	min	max	min	max	max	2 θ 1/2
INV-C33CTMIR	1.8	2.8	350	500	840	860	10	30

*Notes

1. Performance guaranteed only under conditions listed in above tables.
2. Viewing angle(2θ1/2) ± 10°

ESD Precaution

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly. If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

Binning Definition (Binning@700mA)

Power Bin

Bin Code	Min.	Max.	Unit
P38	350	400	mW
P40	400	450	
P45	450	500	

Wavelength Bin

Bin Code	Min.	Max.	Unit
W84	840	860	nm

Voltage Bin

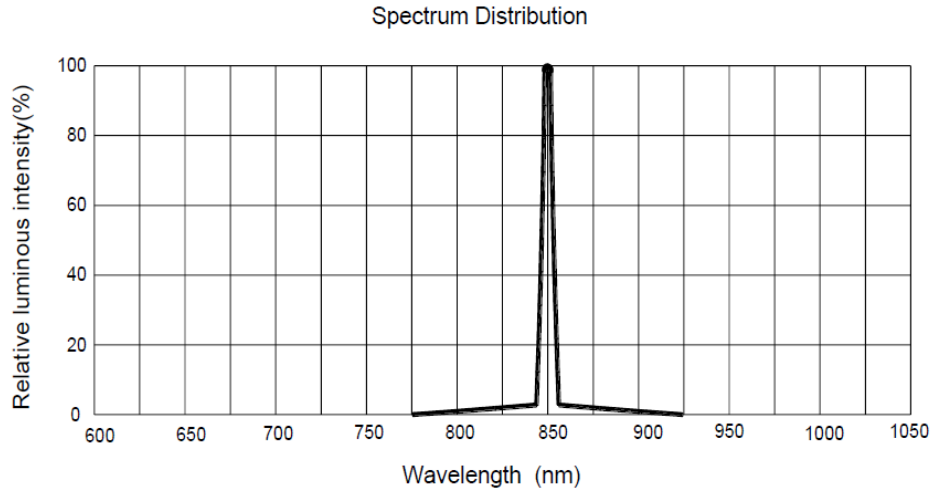
Bin Code	Min.	Max.	Unit
V1	1.8	2.2	V
V2	2.2	2.6	
V3	2.6	2.8	

*Notes:

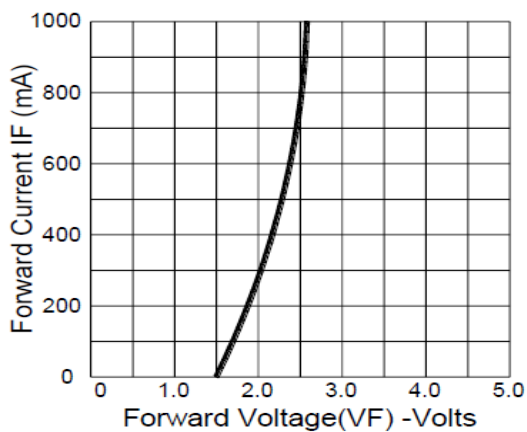
1. Radiometric Power (P_o) $\pm 10\%$.
2. Wavelength (W_p) $\pm 2.0\text{nm}$
3. Forward voltage (V_F) $\pm 0.12\text{V}$

Electronic-Optical Characteristics

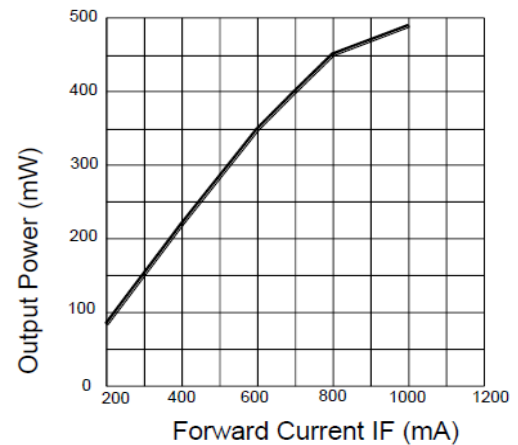
Spectrum Distribution



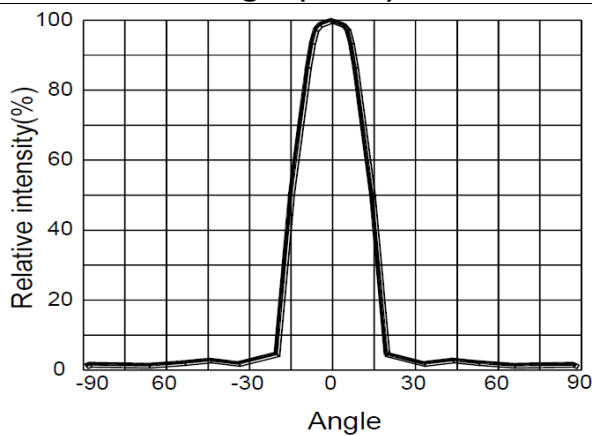
Forward Current VS. Forward Voltage



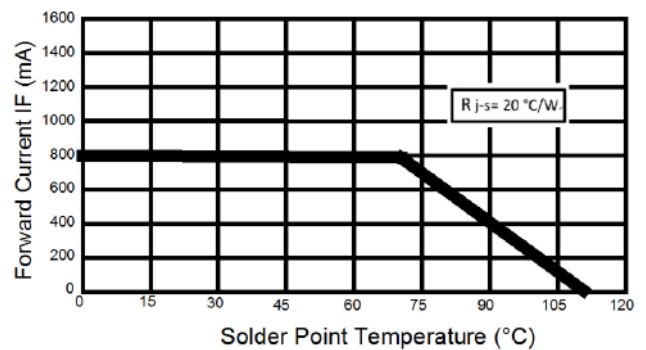
Luminous Intensity VS. Forward Current



Beam angle (2θ1/2) 30D



Thermal Design for De-rating





***Notes:**

Viewing angle (2θ1/2) ± 10°

Ordering Information

Orderable Part Number	Peak Wavelength (nm)	Radiometric Power (mW) @700mA		Forward Voltage (V) @700mA		Viewing Angle
		Min	Max	Min	Max	
INV-C33CTMIR	840-860	350	500	1.8	2.8	30°

Label Specifications

		Date: yyyy/mm/dd
CUSTOMER P/N: 		
INOLUX P/N:	QTY:	PCS
LOT NO: 		
IV BIN:	COLOR BIN:	VF:
		QC

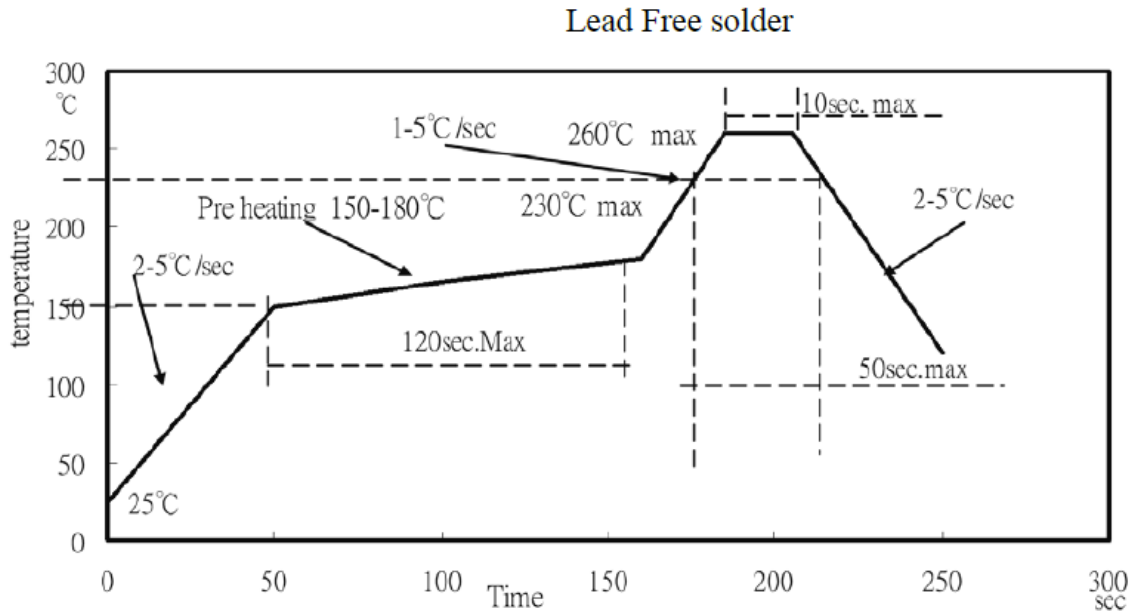
Inolux P/N:

INV	-	C	3	3	C	T	M		IR	-	X	X	X	X
Inolux VCSEL		Material	Package		Variation	Orientation	Current	Lens	Color		Customized Stamp-off			
		C = Ceramic Type	33C = 3.5 x 3.5, 120 Deg.			T = Top Mount	M = 700mA	(Blank) = Clear	IR = 850nm					

Lot No.:

Z	2	0	1	7	01	24	001
Internal Tracker	Year (2017, 2018,)				Month	Date	Serial

Reflow Soldering



Soldering Iron

Basic Spec is ≤ 4 sec. when 260°C ($+10^{\circ}\text{C} \rightarrow -1$ second). Power dissipation of Iron should be less than 15W. Surface temperature should be under 230°C

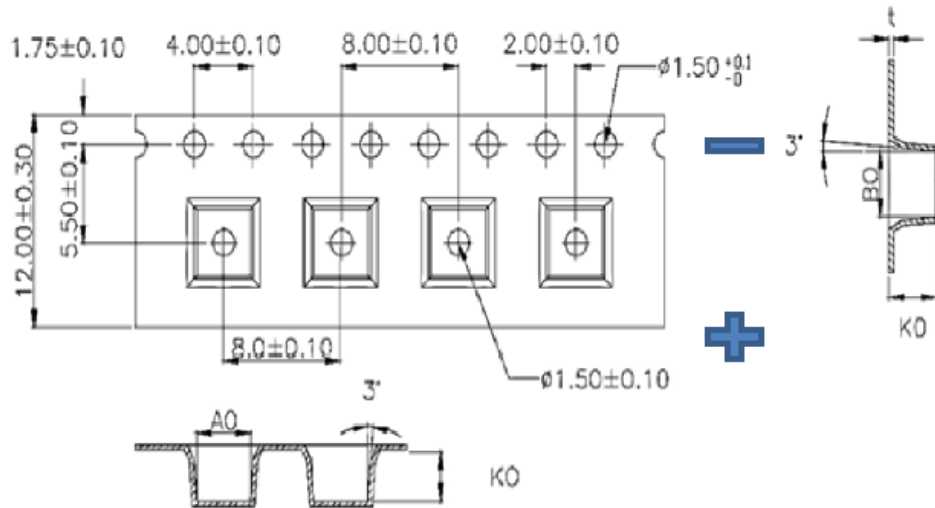
Rework

Rework should be completed within 4 second under 245°C

Notes

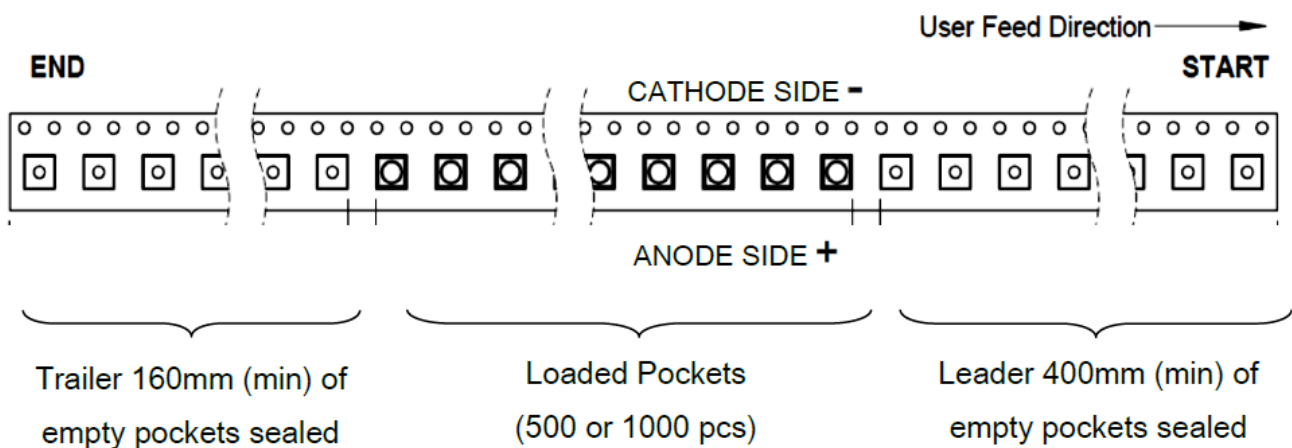
1. Do not stress the silicone resin while it is exposed to high temperature.
2. The number of reflow process should not exceed 3 times.

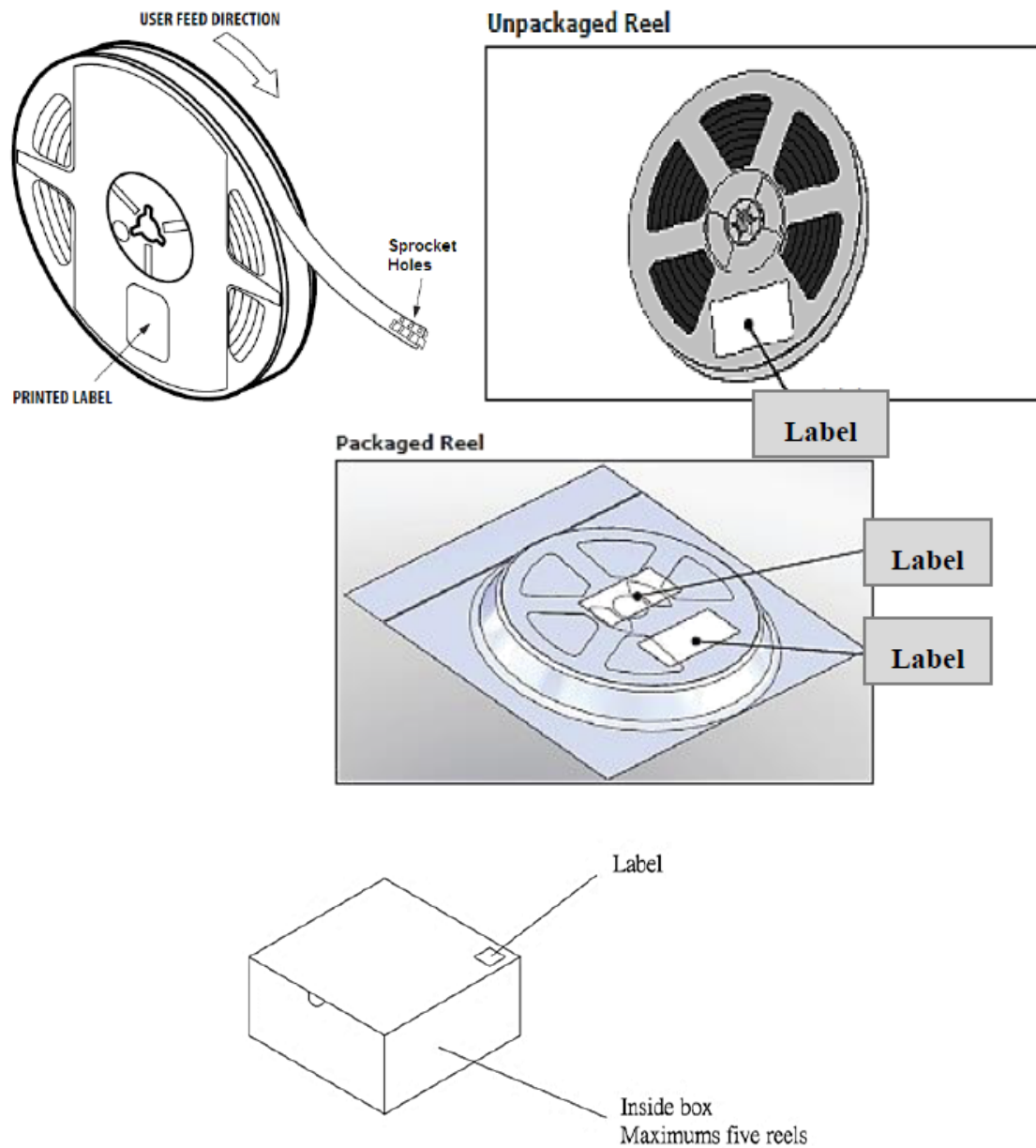
Packing



1. 10 sprocket hole pitch cumulative tolerance ± 0.20 .
2. Carrier camber is within 1 mm in 250 mm.
3. Material : Black Conductive Polystyrene Alloy.
4. All dimensions meet EIA-481-D requirements.
5. Thickness : 0.30 ± 0.05 mm.

T	0.30 ± 0.05
A0	3.80 ± 0.1
B0	3.80 ± 0.1
K0 (60D LENS)	2.90 ± 0.1
K0 (120D LENS)	2.20 ± 0.1





Notes:

1. Each Reel (minimum number of pieces is 100 and maximum is 500 (60D)/1000 (120D) is packed in a moisture-proof bag along with 2 packs of desiccant and a humidity indicator card;
2. A maximum of 5 moisture-proof bags are packed in an inner box (size: 240mm x 200mm x 105mm ± 5 mm)
3. A maximum of 4 inner boxes are put in an outer box (size: 410mm x 255mm x 230mm ± 5 mm)
4. Part No., Lot No., quantity should be indicated on the label of the moisture-proof bag and the cardboard box.

Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	02-03-2019
Revise the Drawing	4	1.1	05-14-2019

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